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The improvement of high-temperature oxidation of Ti–50Al by anodic coating in the phosphoric acid

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Abstract

The high temperature cyclic oxidation resistance of Ti–50Al can be improved by anodic coating in phosphoric acid aqueous solution (4 wt% H₃PO₄) at 18°C. Sparking occurs sporadically on the surface as the voltage is over 300 V and the instantaneous current density after 45 min of anodization increases with increasing voltage. The anodic films are amorphous and contain substantial amount of phosphorus. Cyclic oxidation test indicates that the anodization can remarkably reduce the oxidation in air at 800°C and the improvement increases with increasing anodizing voltage up to 400 V, at which the parabolic oxidation rate constant can be reduced to about 1/600 of that for as-homogenized Ti–50Al. Raman spectra show that the anodic film can slow down the formation of rutile and α -Al₂O₃ during oxidation. The doping effect of phosphorus ions in titanium oxide accounts for the improvement of high temperature oxidation of Ti–50Al. © 2002 Acta Materialia Inc. Published by Elsevier Science Ltd. All rights reserved.

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1. Introduction

The γ -titanium aluminides have been investigated for aerospace application and gas-turbine industry due to their excellent specific strength at high temperature [1,2]. However, the limited ductility at room temperature and the insufficient oxidation resistance at temperatures above 750°C pose a bottleneck to successful applications for years [3,4]. Although alloying design and microstructural control can increase the room temperature ductility of γ -TiAl up to 4% [4], most of alloyed elements, except Nb [5,6], Mo [5,6] and Sb [7] can deteriorate the oxidation resistance. Alloyed γ -TiAl suffers from good balance between specific mechanical properties and sufficient oxidation resistance. Hence, the surface modifications, such as overlayer coatings [8–15], ion implantation [16–18] and preoxidation [19,20], are often employed to enhance the oxidation resistance of γ -TiAl without altering its bulk properties. The current promising methods for barrier coatings on γ -TiAl alloys against high temperature oxidation include pre-oxidizing in pure oxygen [19,20], forming Al₃Ti layer by pack-

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cementation aluminizing [8], air-plasma-spraying ZrO₂-Ni-4.5 wt%Al coatings [9], forming chromium plate by electrolytic method [10], CVDdepositing Al₂O₃ films [11], boronizing by packsintering with B₄C and/or Na₂B₄O₇ powder [12], coating Si₃N₄ by ion-beam-enhanced deposition [13], coating M-CrAlY and/or Al₂O₃ mixture by plasma spray methods [14] and coating aluminosilicate glass by SiO₂ and Al₂O₃ mixture [15]. However, improvement for the cyclic oxidation is limited due to the poor adhesion of these barrier coatings to the substrate, the misfit of thermal expansion coefficients between the coatings and substrate, and/or the intrinsic brittleness of the coatings. Extensive works have endeavored to enhance the oxidation resistance of y-TiAl by ion implantation. The ion beam includes elemental species which can promote alumina (Al₂O₃) formation, such as Nb, P, Cl, Al, Mo, Si, Cr, Ar, B, N and O [16-18]. Among them, the most promising species are phosphorus ion and Nb ion. However, the ion implantation requires costly and sophisticated equipment. Besides, the conformal coverage is an intrinsic drawback for workpieces with complex shapes.

Microalloying of phosphorus in γ-TiAl alleviates its high temperature oxidation [21]. Moreover, Retallick et al. have employed painting phosphoric acid onto the γ -TiAl and subsequent calcining to substantially improve the oxidation resistance at 800°C by reducing two orders of magnitude in oxidation rate [22]. Although this process has the merits of good conformal coverage, low facility cost and easy operation, yet time-consuming and poor appearance after treatment leave space for further improvement. Phosphoric acid is a well-known solution for anodizing aluminum alloys [23]. In addition, for the passivation of the anodized titanium alloys, the phosphate-based materials give by far the best results among various electrolytes [24]. The beneficial characteristic of phosphorus against oxidation resistance and the satisfactory performance of titnaium and aluminium alloys anodizied in phosphoric acid solution reveal that anodic coating of y-TiAl in phosphoric acid solution seems to be feasible and deserves to be investigated.

2. Experimental procedures

The Ti-50Al was prepared from titanium and aluminum (99.98%) using a (99.7%)vacuum/argon tungsten arc furnace. The ingots were homogenized at 1150°C in vacuum for 75 h and furnace-cooled to room temperature. The single y-TiAl, confirmed by X-ray diffraction and metallographic observation (optical microscopy and scanning electron microscopy), excludes the possibility of the presence of α_2 -Ti₃Al in the ingot. The homogenized ingots were sectioned into $0.8 \times 1.0 \times 13$ (mm³) by Buehler Iosmet low speed diamond saw. The surface was mechanically polished through a standard metallographic procedure to a final polishment of 0.3 µm alumina and cleaned ultrasonically in acetone and ethanol for 5 min sequentially and then rinsed with deionized water.

The dimension of the specimen and the exposed area for anodization were delineated by a 3-M tape and measured to an accuracy of 0.1 mm by an optical microscope. The polished specimens were anodized with various constant direct current (DC) voltages in the electrolytic solution of 4 wt% phosphoric acid (Merck Co.) at $18\pm0.5^{\circ}$ C for 45 min. The electrolytic solution was stirred continuously during anodization. The separation between the specimen and the counter-electrode (platinum-coated titanium net) was 5 cm. After anodization, the specimens were rinsed in running water for at least 30 min.

The cyclic oxidation behaviors of anodized specimens were characterized by exposing the specimens to hot air (800°C) from a muffle furnace. They are regularly removed from the muffle furnace, then air cooled, weighed and returned to the 800°C furnace. The weight gains per exposed area (mg/mm²), weighed on an analytical balance to an accuracy of $\pm 10^{-3}$ mg, were used to evaluate the oxidation resistance.

The crystal structures of oxide scales were determined by using a grazing angle X-ray diffractometer (GXRD) with CuK α radiation at 45 kV, 30 mA and 4°(2 θ)/min scanning rate at a grazing angle of 4°. The microstructural observation was carried out by a Philips XL30 scanning electron microscope (SEM) equipped with the energy dispersive spectrometry (EDX). Depth profiles of the chemical composition of anodic coatings were determined by glow discharge optical spectroscopy (GDOS) [25].

Since titanium oxide is a strong Raman scatter [26], Raman spectra were used to characterize the oxide film in this study. The Raman spectra were recorded on a Renishaw system 2000 micro-Raman spectrometer with a He–Ne laser (632.8 nm wavelength) or Ar⁺ laser (514.5 nm wavelength) as the excitation source. With a 5- μ m exit slit width, the Raman spectral resolution was better than ± 1 cm⁻¹. The laser power used was 8 mW for He–Ne laser and 50 mW for Ar⁺ laser. All Raman spectra were taken at room temperature.

3. Results and discussion

3.1. Anodizing process of Ti-50Al specimen

At the early stage of constant-voltage anodization of Ti-50Al in phosphoric acid at 18°C, oxygen evolution takes place as bubbles attached on the surface of anode and increases with increasing the applied voltage. Therefore the removal of the bubbles is required for uniform anodic coating by interrupting the process after about 60 s anodization. Hereafter, the oxygen evolution on the surface of the anode (specimen) is not observed for the latter period of anodization if the applied DC voltage is below 350 V. The thickness of the passive film should increase when the anodizing proceeds, as confirmed later, resulting in the decrease of the field strength [27]. Hence, the current density of anodization of Ti-50Al in phosphoric solution falls rapidly at the early stage and then decreases monotonically during the course of anodization, as shown in Fig. 1. As the applied voltage increases, the current intensity fluctuates more and more rapidly. If the applied voltage is over 350 V, sparking breakdown occurs, i.e., the intensive sparks and oxygen evolution starts, and then both the sporadic sparks and oxygen evolution happen less intensively for the later period of anodization. For a higher anodizing voltage, such as 400 V, the sparks occur very violently and oxygen evolution aggressively bursts into bubbles during the course

of anodization. The anodic films formed at the voltage over 350 V are found to be tarnished.

Fig. 2 shows the relationships between the applied voltage and the current density at the end (45 min) of the anodization in phosphoric acid at 18°C. The final current densities increase with increasing the applied voltage and reach a maximum at around 225 V. When the voltage is over 225 V, the final current densities decrease with increasing the applied voltage. The ratio of applied voltage to current density roughly represents the resistance per unit area of anodic film since the resistance of the circuit is negligible in contrast to the high resistance of the passive anodic coating. It can be seen that the resistance per unit area considerably increases when the applied DC voltage is over 225 V. The reduction in current density for the anodizing voltage higher than 225 V in Fig. 2 may be attributed to the fact that the increase of the resistance per unit area overwhelms the increase of the applied voltage. The final current density ranges from $9.6 \times 10^{-8} \text{ mA/mm}^2$ (60) V) to $3.2 \times 10^{-7} \text{ mA/mm}^2$ (225 V) in this study.

The weight gain per unit area after anodizing in phosphoric acid at 18°C for 45 min vs. the anodizing voltage is shown in Fig. 3. The weight gain per unit area increases with the increase in applied voltage and tends to level off when the applied voltage is above 300 V. This may be associated with the electrical field-assisted dissolution and the existence of sparks on the surface during anodization, which may locally raise the temperature and increase the dissolution effect of phosphoric acid since phosphoric acid is a well-known electrolytic solution with solvent action [28]. The accelerated dissolution counterbalances the weight gain of anodizing oxidation and results in the leveling-off of the curve when the applied voltage is over 300 V, as shown in Fig. 3.

3.2. Microstructure of the anodic coatings

Fig. 4 shows the plan-viewed morphologies of as-anodized Ti–50Al. The higher the voltage applied, the more the rugged surface formed. This indicates that solvent action of phosphoric acid occurs during anodization and confirms that the



Fig. 1. The variation of current density with time under various anodizinig voltages in 4 wt% phosphoric acid at 18°C.



Fig. 2. Effect of anodizing voltage on the current density and resistance (per unit area) of anodized film.

increase in the anodized voltage can enhance the solvent action of phosphoric acid.

Fig. 5 demonstrates the depth profiles of elements Ti, Al, O, P and H (in at.%) of the anodic films formed at various DC voltages in 18°C phosphoric acid solution. In addition to oxygen, the anodization in phosphoric solution can bring into a significant concentration of phosphorus in the anodic film and the penetration depth of phosphorus also increases as the applied voltage increases. The content of titanium is less than that of aluminum in the anodic films. This implies that preferred solvent solution may occur. From Fig. 5, the thicknesses of the anodic film prepared at 160, 300 and 400 V are evaluated as 0.23, 0.65 and ≈ 2 µm, respectively. That is, the thickness of the anodic film increases upon increasing the applied DC voltage. This result is in consistent with the SEM observation for the anodic coatings shown in Fig. 6(a) (300 V) and Fig. 6(b) (400 V). In Fig. 6(b), for the rugged anodic coating prepared at 400 V, the average thickness of its anodic film determined by GDOS is about 2 µm.

The GXRD patterns of the anodic films formed at various voltages in 18°C phosphoric acid solution are shown in Fig. 7 which shows that only



Fig. 3. Effect of anodizing voltage on the weight gains after anodization.

 γ -TiAl diffraction peaks appear with superposed amorphous signals. In general, the sparking and accompanied gas breakdown of anodization usually result in the crystallization of the anodic films [29]. However, even for 400 V anodization in phosphoric acid solution, at which violent sparking occurs, the crystallization of anodic film on TiAl is not found. The anodic films prepared at higher DC voltages give more amorphous signals in GXRD patterns of Fig. 7. This is attributable to the fact that the higher the anodizing voltage, the more the thickness of anodic amorphous film, as confirmed in Fig. 5.

3.3. The cyclic oxidation kinetics of Ti–50Al with the anodic coatings

As-homogenized Ti–50Al loses its metallic luster within 5 h exposure in static air at 800°C and has serious scale spallation after about 35 h of oxidation. However, for Ti–50Al anodized in phosphoric acid, the anodic shinning color is more durable. The anodic coating formed at 300 V remains its original color luster even after 70 h cyclic exposure in static air at 800°C.

Fig. 8 shows the cyclic oxidation kinetics in static air at 800°C for Ti–50Al which has been anodic-coated in the electrolyte of 4 wt% phosphoric acid at 18°C under various anodizing voltages for 45 min. As mentioned above, the oxidation curve for as-homogenized Ti–50Al is so scattered due to the scale spallation. This implies that the scale adherence is not good and the oxide

layer is very brittle and fragile. The oxidation curve of as-homogenized Ti-50Al, measured by TGA is shown in Fig. 8, indicates that the oxidation rate does not completely obey the parabolic law in all periods of oxidation. However, if the specimen has been anodized in phosphoric acid, no scale spallation occurs during cyclic oxidation. The anodic film on the Ti-50Al adheres very well to the substrate. As shown in Fig. 8, the anodizing process in phosphoric acid can substantially reduce the oxidation rate of Ti-50Al. Initially, the oxidation behavior of the anodized specimen seems to be quasi-linear and then gradually shifts toward the parabolic law. After about 10 hrs of oxidation, the parabolic oxidation law dominates the oxidation rate. The parabolic oxidation rate constant, kp, can be calculated from the curve fitting of Fig. 8 and this constant can be used as a convenient index for comparing the oxidation resistance.

Fig. 9 plots the calculated kp value vs. applied DC voltage. For specimen anodized at 60 V, kp is 0.00343 mg²/cm⁴h, in contrast to 0.041 mg²/cm⁴h for as-homogenized Ti–50Al. The increase in anodizing voltage leads to the decrease in kp, i.e., enhances the oxidation resistance of Ti–50Al. For the Ti–50Al specimen anodized at 400 V for 45 min, kp can be further reduced to 0.000068 mg²/cm⁴h, which is about 1/600 of kp for as-homogenized Ti–50Al.

3.4. Raman spectra of anodized Ti–50Al after cyclic oxidation

Fig. 10 shows the Ar⁺ laser-excited Raman spectra of the as-homogenized Ti–50Al after various durations of cyclic oxidation at 800°C in air. The characteristic rutile spectrum in this range are the peaks at 447 cm⁻¹ (Eg) and 610 cm⁻¹ (A1g) [30]. It is evident that only rutile phase appears and its volume increases with the increase in oxidation time. To distinguish the crystal structure of alumina from rutile on the surface of Ti–50Al, the most suitable excitation source is the He–Ne laser (632.8 nm) [31]. The peaks at 1374 cm⁻¹ and 1403 cm⁻¹ of Fig. 11 are the characteristic Raman spectra of α -Al₂O₃ [31], which is a spinel structure. Similar trends and phenomena are also found on Ti–50Al with anodic coating at 300 V, as shown



Fig. 4. Plan-viewed morphologies of anodized Ti-50Al under various voltages for 45 min in 4 wt% phosphoric acid at 18°C.

in Figs. 12 and 13, however, both the intensities of rutile and α -Al₂O₃ are less than those of the as-homogenized Ti–50Al. This indicates that the anodic film can slow down the formation of oxides during the oxidation. The peaks can be deconvoluted according to Raman spectra of the pure ana-

tase, rutile and α -Al₂O₃. The peaks at 392 cm⁻¹ (B1g), 513 cm⁻¹ (A1g–B1g) and 635 cm⁻¹ (Eg) are associated with the Raman shifts of anatase [32]. The anodization by 300 V can not only slow down the transformation of amorphous oxide into crystalline oxide, but also inhibit the transform-



Fig. 5. Glow discharge optical spectra (GDOS) of the anodic films formed at different voltages (a) 160 V, (b) 300 V, (c) 400 V.







Fig. 6. The SEM cross-sectional morphologies of Ti=50Al with anodic coatings prepared at different DC voltages (a) 300 V, (b) 400 V.

ation of titatium oxide into the thermodyamic stable phase (rutile). At 400 V, experimental results show that a substantial amount of anatase phase is still present even after the exposure in 800°C air for 70 h. Obviously, 400 V anodic coating can further depress the formation of α -Al₂O₃.

3.5. The phosphorus effect on the improvement of high temperature oxidation of Ti–50Al

Titanium oxide is a well-known n-type semiconductor [33]. This is the main reason for the poor protectiveness against the oxidation resistance of γ -TiAl [1,4]. In this study, the introduction of a substantial amount of phosphorus into the anodic film is evidently shown in Fig. 5. Phosphate is a



Fig. 7. The GXRD patterns at 4° grazing angle of incidence of the anodic films formed at different voltages.

strong catalyst for the crystallization of anatase [34]. Anatase is a metastable phase which transforms exothermically and irreversibly to rutile. Moreover, the high dose of phosphorus doping in

an anodic film can result in two effects: (1) The total impurity content can affect the transformation through the structure stuffing effect. Large quantities of impurities raise the transformation temperature. (2) The nature of the impurities appears to control the stoichiometry of the TiO₂ and thus affects the oxygen vacancy concentration. Ions of valence greater than four, e.g., $P^{5+}(3S^2P^3)$, would correspondingly reduce the oxygen vacancy concentration and the transformation rate [35,36]. The disappearance of oxygen ion vacancies in titanium oxide reduces oxygen supply to the oxide/metal interface and enhances the protectiveness of titanium oxide. Hence, more phosphorus atoms in an anodic film, resulting from the increase in the anodizing DC voltage, will lead to a better oxidation resistance of γ -TiAl at high temperature. Regarding the oxidation investigation of γ -TiAl implanted a few 100 ppm phosphorus by high-resolution XRD method, Schumacher et al. [37] reported that the phosphorus doping of TiO_2 can lower the diffusion rates of Ti and Al in the TiO₂ lattices. This causes a change of the growth direction of the alumina partial layer from outward to inward growth, and reduces the oxygen diffusion rate simultaneously. Although the phosphorus concentration in the anodic film is much higher than that in the implanted layer, the model of phosphorus doping in TiO₂ seems can also be applied to explain the significant improvement of high temperature oxidation of γ -TiAl observed in this study.



Fig. 8. The oxidation kinetics in static air at 800°C for Ti–50Al anodized in the electrolyte of 4 wt% phosphoric acid at 18°C under various anodizing voltages for 45 min.



Fig. 9. Effects of anodizing voltage on oxidation resistance (parabolic rate constant kp) of Ti-50Al in static air at 800°C.





Fig. 11. The He–Ne laser excited Raman spectra of the ashomogenized Ti–50Al after exposure in air at 800° C for various durations.

Fig. 10. The Ar^+ laser excited Raman spectra of the as-homogenized Ti–50Al after exposure in air at 800°C for various durations.



Fig. 12. The Ar⁺ laser excited Raman spectra of the anodized Ti–50Al after the exposure in air at 800° C for various durations. Anodization was carried out at 300 V.

4. Conclusions

The high temperature cyclic oxidation resistance of Ti-50Al can be improved by anodic coating in 4 wt%, 18°C phosphoric acid solution. The current density of anodization decreases monotonically during anodization under a constant voltage. The spark occurs sporadically on the specimens as the voltage is over 300 V and the instantaneous current density after 45 min of anodization increases with increasing the voltage. The 4 wt% phosphoric acid solution at 18°C has some solvent action during anodization, which leads to the fact that the higher the voltage is applied, the more the rugged surface it has. The anodic films are amorphous and contain substantial amount of phosphorus. Cyclic oxidation test at 800°C air indicates that the anodized Ti-50Al can remarkably reduce the oxidation rate and the improvement increases with the increasing ano-



Fig. 13. The He–Ne laser excited Raman spectra of the anodized Ti–50Al after the exposure in air at 800°C for various durations. Anodization was carried out at 300 V.

dizing voltage up to 400 V, at which the parabolic rate constant kp can be reduced to about 1/600 of that for as-homogenized Ti–50Al. The studies of Raman spectra of anodized Ti–50Al after cyclic oxidation indicate that the anodic film can slow down the formation of rutile and α -Al₂O₃ on the surface during the oxidation, with the former oxide being more depressed than the latter one. The doping effect of phosphorus ions in titanium oxide is attributable to the improvement of high temperature oxidation of Ti–50Al.

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